Contact Name Title - Contact Product-Env-Stewards Product Enviro Compliance Authorized Representative* Product-Env-Stewards Product Enviro Compliance NA Product-Env-Stewards	ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
Company name* Company unique ID Unique ID Authority Response Date* 2024-05-11 2024-05-11 Contact Name Title - Contact* Phone - Contact* Product-Env-Stewards Product-En	752-21.1					*						g Informat	ion			
Semil Formatic Name Title - Contact Name Title - Contact Name Product Env-Stewards Product Enviro Compliance NA Product Env-Stewards Product Env-Stewards Product Enviro Compliance NA Product Env-Stewards	upplier Informa	ation														
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Product-Env-Stewards Authorized Representative* Title - Representative Product Enviro Compliance Product Enviro Compliance NA Product Env-Stewards Product Enviro Compliance NA Product-Env-Stewards	nsemi								2				2024-05-11			
Authorized Representative* Product-Env-Stewards Product Enviro Compliance Requester Item Number Mfr Item	Contact Name		Title - Contact			I	Phone - Contact*				Email - Contact*					
Product Envis Compliance Requester Item Number Mfr Item Number	Product-Env-Stewar	rds	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requester Item Number	Authorized Representative* Titl				Title - Representative			Phone - Representative*			Email - Representative*					
SC431AVSNT1G ANA 2.5V PROG SHUNT REF 2024-05-11 MY1 8.14 mg Each	Product-Env-Stewar	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
Manufacturing Proccess Information Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3	Requester	Requester Item Number Mfr Item			m Number Mfr Item Name			Effective Date	ective Date		Anufacturing Site	V	/eight*	UOM	Unit Type	
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles 260 Comments			SC431AV	VSNT1G	ANA 2.5V PROG S	SHUNT REF		2024-05-11		N	ЛҮ1	8.	.14	mg	Each	
Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3 comments				ampinal Daga	Allow	STD 020 MSI	Dating	Dools Droop	ana Dadu T	·	Mov Time at Deals	Tommoroto	no Numb	act of Deflow Cve	las.	
omments	2 2			The state of the s		L Kaung						ber of Reflow Cyc	ies			
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ver 1 - maximum ume at peak temperature during soldering is 10-30 seconds		me at week termoneture	duning gale	domina ia 10 3	20 seconds											
or more information regarding material composition please refer to page 3																

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.16	mg	Supplier	Silicon (Si)	7440-21-3		0.16	mg
Die Attach	0.18	mg		Epoxy resin	proprietary data		0.054	mg
			Supplier	Fatty acids, C18-unsatd., dimers, polymers with epichlorhydrin	68475-94-5		0.054	mg
			Supplier	2,2'-[[2-(oxiranylmethoxy)-1,3-phenylene]bis(methylene)]bisoxirane	13561-08-5		0.054	mg
			Supplier	4-Methyl-2-Phenyl-1H-Imidazole	827-43-0		0.0162	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0018	mg
Lead Frame	2.75	mg	Supplier	Silver (Ag)	7440-22-4		0.1375	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0033	mg
			Supplier	Iron (Fe)	7439-89-6		0.066	mg
			Supplier	Copper (Cu)	7440-50-8		2.541	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0022	mg
Mold Compound-Black	4.9	mg		Epoxy resin	proprietary data		0.245	mg
			Supplier	Phenolic Resin	Proprietary Data		0.245	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.098	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0245	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.2875	mg
Plating	0.14	mg	Supplier	Tin (Sn)	7440-31-5		0.14	mg
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg